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FORM PTO-1596 RE(U.S. Department of Patent and Trader	
	01100337	- 2
1. Name of conveying party(ies): 1) Wei-Yung Hsu 2) Qi-Zhong HOng	Name and Address of receiving party(ies): Name: TEXAS INSTRUMENTS INCORPORATED Address: P.O. Box 655474, MS 3999 City: Dallas State: TX Zip: 75265	Jesse U. 8.
3. Nature of Conveyance:	Additional name(s) & address(es) attached? Yes _X_	_ No
X_ Assignment Merger Security Agreement Change of Name Other Execution Date: August 13, 1998		
4. Application number(s) or patent number(s).		
ETCH BACK PROCESSING Docket No: TI-23689	E OF ALUMINUM METALLIZATION FOR TU	NGSTI
ETCH BACK PROCESSING Docket No: TI-23689 A. Patent Application No.(s) S.N.	B. Patent No.(s)	
ETCH BACK PROCESSING Docket No: TI-23689 A. Patent Application No.(s) S.N. Additional numbers attached?YesXNo 5. Name and address of party to whom correspondence concerning document should be mailed: Name: Jacqueline J. Garner Texas Instruments Incorporated Address: P.O. Box 655474, MS 3999 City: Dallas		No
ETCH BACK PROCESSING Docket No: Ti-23689 A. Patent Application No.(s) S.N. Additional numbers attached?YesX No 5. Name and address of party to whom correspondence concerning document should be mailed: Name: Jacqueline J. Garner Texas Instruments Incorporated Address: P.O. Box 655474, MS 3999	B. Patent No.(s) Additional numbers attached? YesX	No
ETCH BACK PROCESSING Docket No: Ti-23689 A. Patent Application No.(s) S.N. Additional numbers attached?YesX No 5. Name and address of party to whom correspondence concerning document should be mailed: Name: Jacqueline J. Garner Texas Instruments Incorporated Address: P.O. Box 655474, MS 3999 City: Dallas	B. Patent No.(s) Additional numbers attached?YesX 6. Number of applications and patents involved:(1)	No
ETCH BACK PROCESSING Docket No: TI-23689 A. Patent Application No.(s) S.N. Additional numbers attached?YesX No 5. Name and address of party to whom correspondence concerning document should be mailed: Name: Jacqueline J. Garner Texas Instruments Incorporated Address: P.O. Box 655474, MS 3999 City: Dallas State: TX Zip: 75265	B. Patent No.(s) Additional numbers attached?YesX 6. Number of applications and patents involved:(1) 7. Amount of fee enclosed or authorized to be charged: \$4	No

PATENT REEL: 010109 FRAME: 0138

TI-23689

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 7839 Churchill Way, MS 3999 Dallas, Texas 75251, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in and to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE OF INVENTION	METHOD OF IMPROVING THE TEXTURE OF ALUMINUM METALLIZATION FOR TUNGSTEN ETCH BACK PROCESSING	
SIGNATURE OF INVENTOR AND NAME	Wei-Yung Hsu	Qi-Zhong Hong
DATE	X 8113198	x 8/13/88
RESIDENCE (City, County, State)	Dallas Dallas Texas	Dallas Dallas Texas
DATE APPLICATION EXECUTED	e113198	8/13/8f

After recording return Assignment to:

Carlton H. Hoel Texas Instruments Incorporated P.O. Box 655474, M/S 3999 Dallas, TX 75265

> PATENT REEL: 010109 FRAME: 0139